

General Description

- Trench Power MV MOSFET technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- Optimized for fast-switching applications

Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Industrial and Motor Drive applications

Product Summary

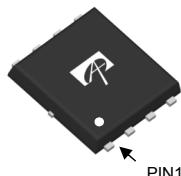
V_{DS}	45V
I_D (at $V_{GS}=10V$)	100A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 2.6mΩ
$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 4mΩ

100% UIS Tested
100% R_g Tested

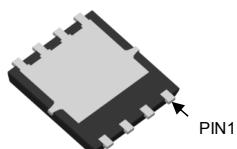


DFN5x6

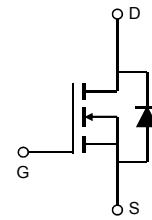
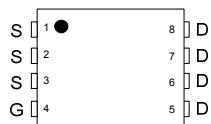
Top View



Bottom View



Top View



Orderable Part Number

AON6156

Package Type

DFN 5x6

Form

Tape & Reel

Minimum Order Quantity

3000

Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	45	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^G $T_C=25^\circ C$	I_D	100	A
		82	
Pulsed Drain Current ^C	I_{DM}	260	A
Continuous Drain Current $T_A=25^\circ C$	I_{DSM}	36	A
		29	
Avalanche Current ^C	I_{AS}	32	A
Avalanche energy L=0.3mH ^C	E_{AS}	154	mJ
V_{DS} Spike	V_{SPIKE}	54	V
Power Dissipation ^B $T_C=25^\circ C$	P_D	78	W
		31	
Power Dissipation ^A $T_A=25^\circ C$	P_{DSM}	6.2	W
		4.0	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A $t \leq 10s$	$R_{\theta JA}$	15	20	°C/W
Maximum Junction-to-Ambient ^{A,D} Steady-State		40	50	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	1.3	1.6	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	45			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =45V, V _{GS} =0V T _J =55°C		1	5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.5	1.9	2.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A T _J =125°C		2.1	2.6	mΩ
		V _{GS} =4.5V, I _D =20A		3.4	4.2	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =20A		100		S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V		0.67	1	V
I _S	Maximum Body-Diode Continuous Current				90	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =22.5V, f=1MHz		3975		pF
C _{oss}	Output Capacitance			545		pF
C _{rss}	Reverse Transfer Capacitance			62		pF
R _g	Gate resistance	f=1MHz	0.3	0.7	1.1	Ω
SWITCHING PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =22.5V, I _D =20A		50	70	nC
Q _g (4.5V)	Total Gate Charge			23	35	nC
Q _{gs}	Gate Source Charge			11		nC
Q _{gd}	Gate Drain Charge			5		nC
t _{D(on)}	Turn-On Delay Time	V _{GS} =10V, V _{DS} =22.5V, R _L =1.125Ω, R _{GEN} =3Ω		11		ns
t _r	Turn-On Rise Time			4		ns
t _{D(off)}	Turn-Off Delay Time			38		ns
t _f	Turn-Off Fall Time			4		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =20A, di/dt=400A/μs		19		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =20A, di/dt=400A/μs		43		nC

A. The value of R_{0JA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The Power dissipation P_{DSM} is based on R_{0JA} ≤ 10s and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Single pulse width limited by junction temperature T_{J(MAX)}=150° C.

D. The R_{0JA} is the sum of the thermal impedance from junction to case R_{JJC} and case to ambient.

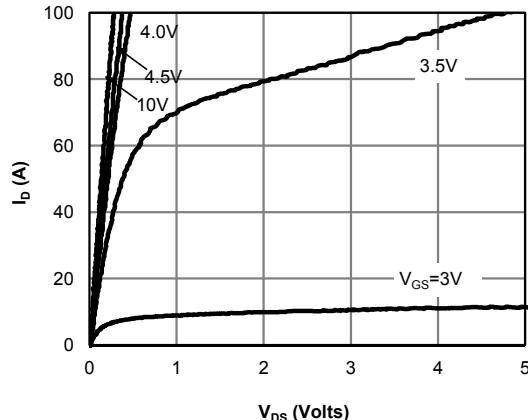
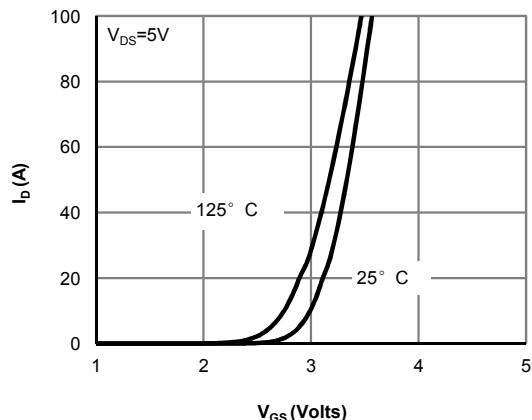
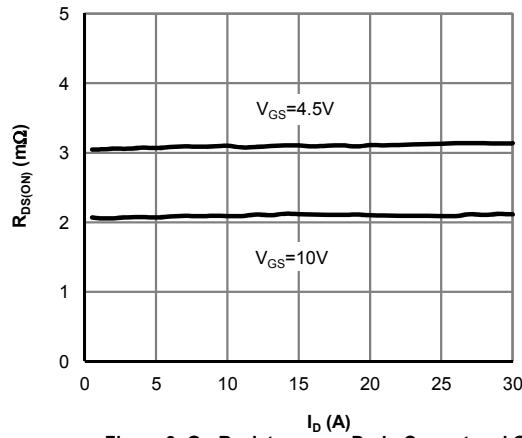
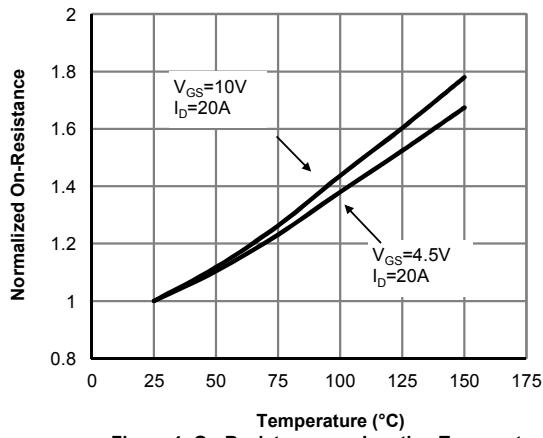
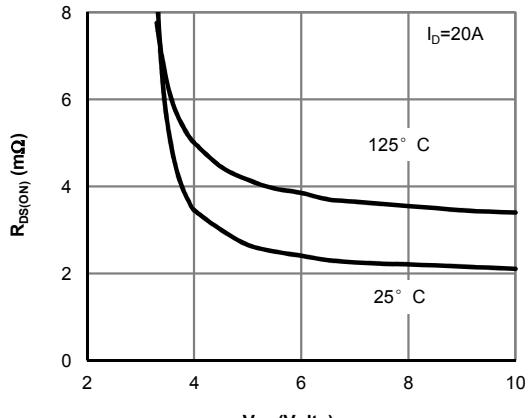
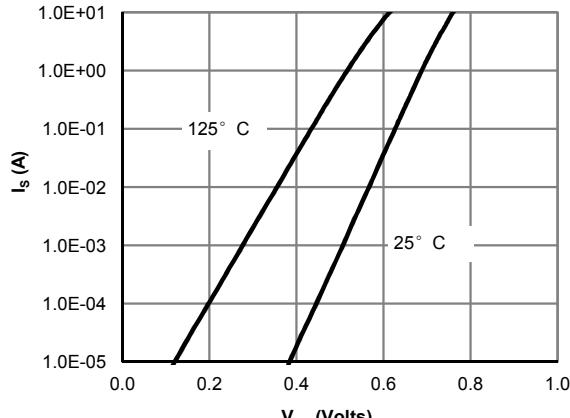
E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

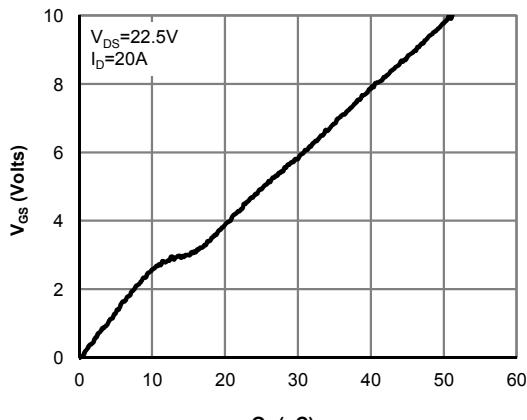
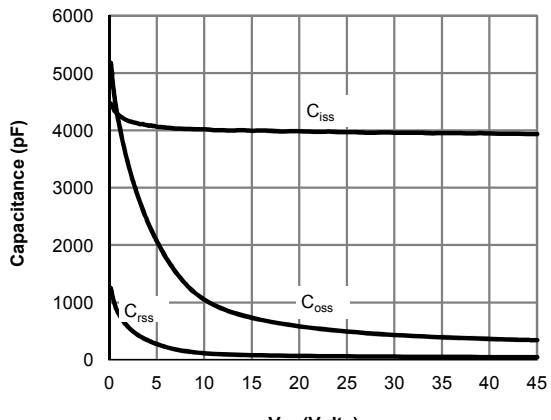
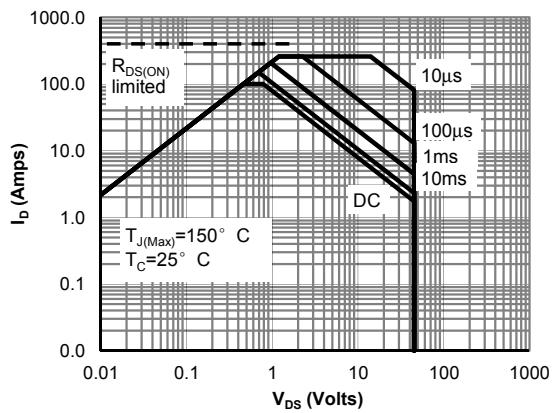
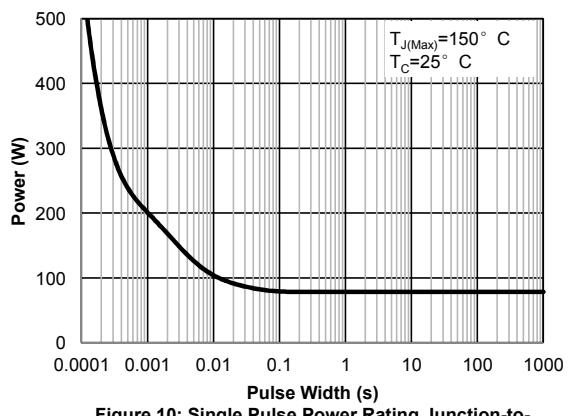
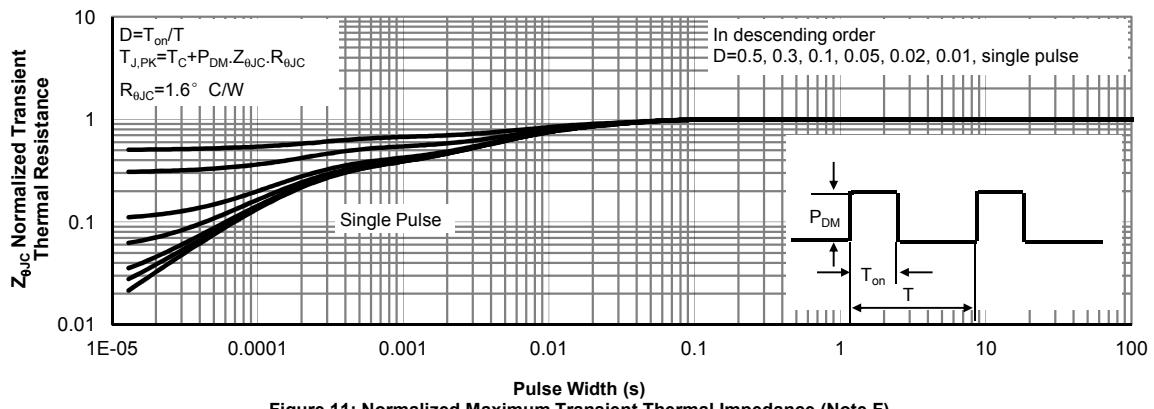
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

Figure 10: Single Pulse Power Rating Junction-to-Case (Note F)

Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

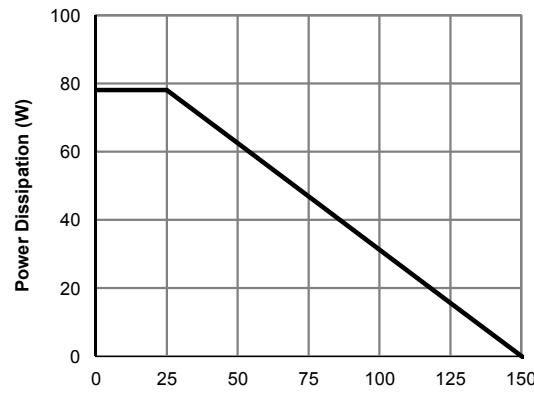
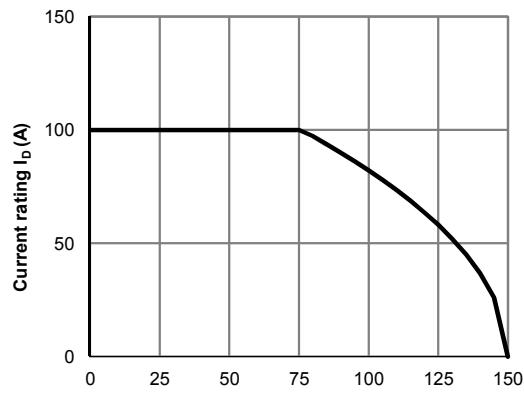
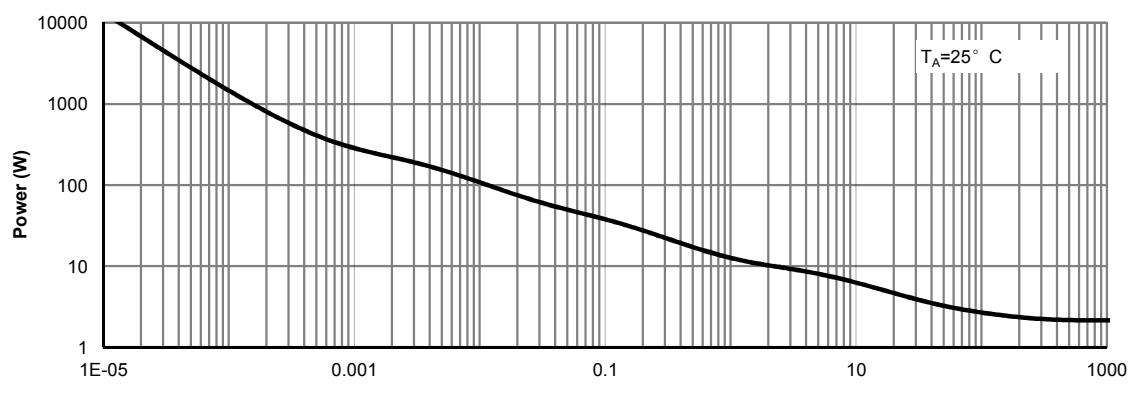
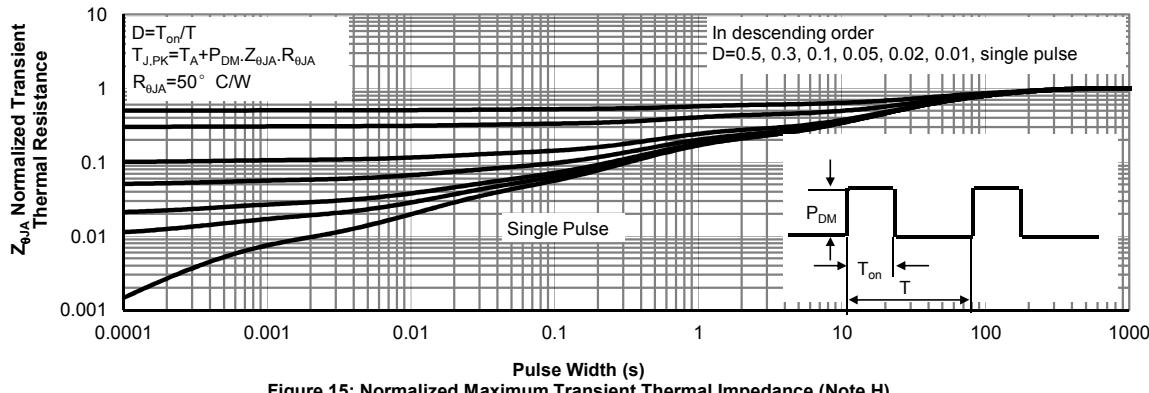
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 12: Power De-rating (Note F)

Figure 13: Current De-rating (Note F)

Figure 14: Single Pulse Power Rating Junction-to-Ambient (Note H)

Figure 15: Normalized Maximum Transient Thermal Impedance (Note H)

Figure A: Gate Charge Test Circuit & Waveforms

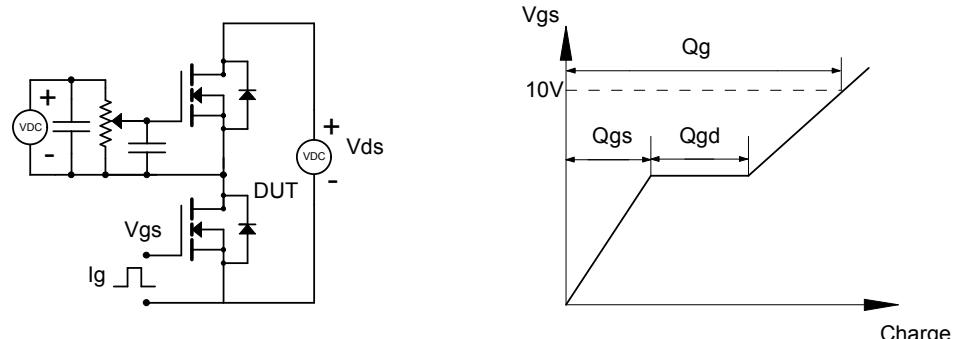


Figure B: Resistive Switching Test Circuit & Waveforms

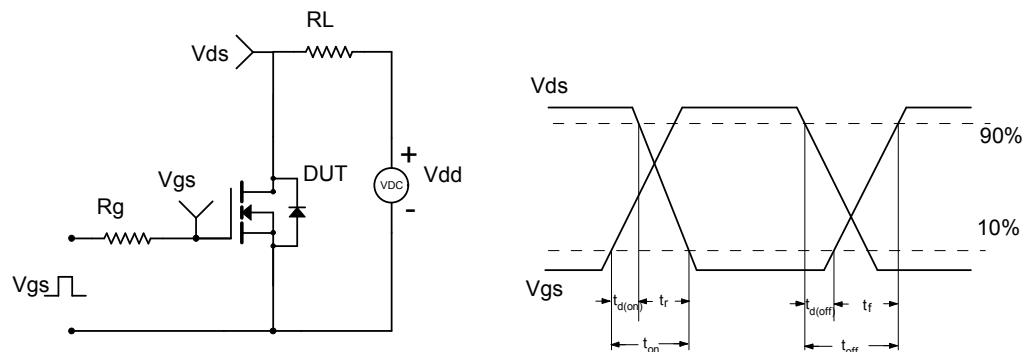


Figure C: Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

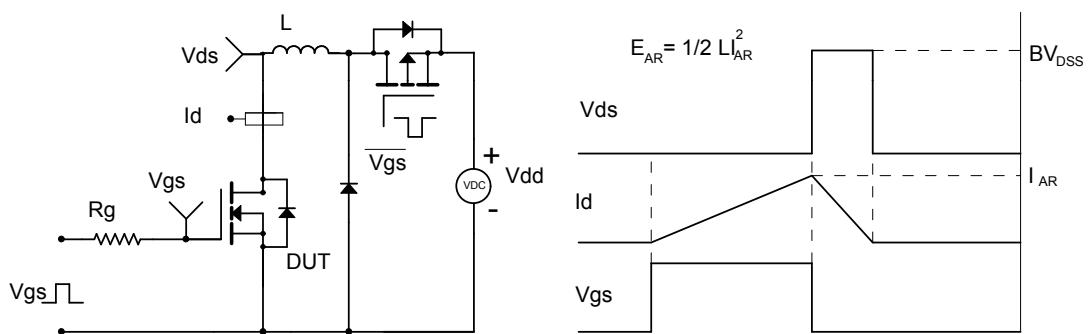


Figure D: Diode Recovery Test Circuit & Waveforms

